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1. Introduction and Project Outline

The project surrounds the process of detecting components in a circuit board, streamlining the automated procedure of detection and reducing the human workload required in doing such a task.

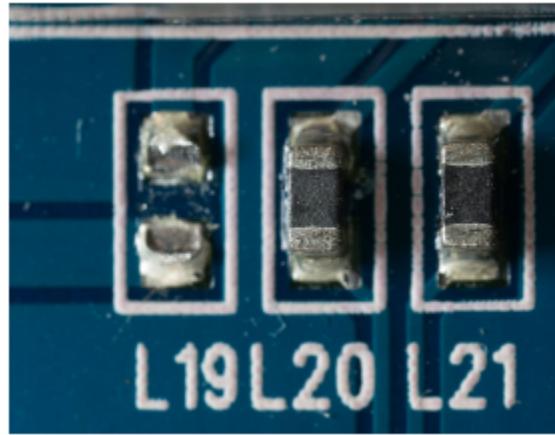


Figure 1: Missing Component in Circuit Board [1]

The following below are the circuit boards to be used for evaluation.

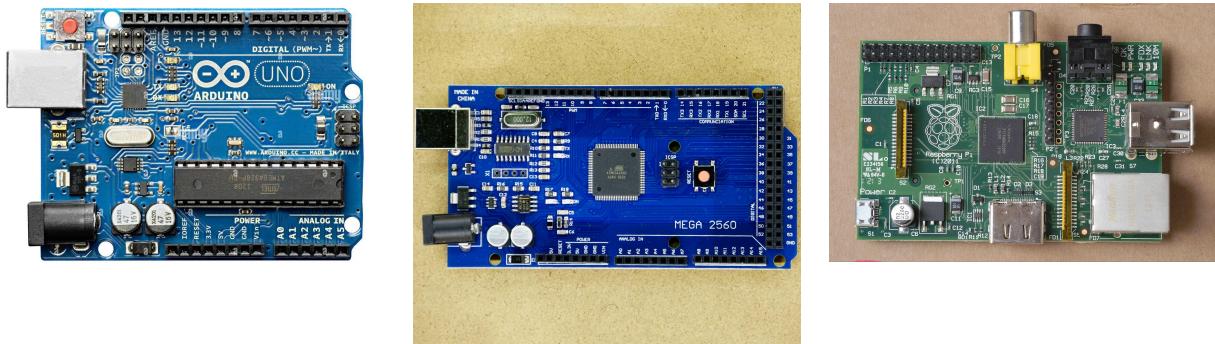


Figure 2: Evaluation Circuit Boards

2. Results & Discussion

The following are the steps taken in the project, the code for which is uploaded in the GitHub repository which is linked in the Appendix. The code was also zipped and linked alongside the submission of this report.

2.1 - Object Masking

To start off, object masking is used to remove the unnecessary part of the image when needed for training purposes. In this case, a sample motherboard is used to demonstrate the process. The `cv2.cvtColor()` is used to grayscale the image and `cv2.threshold()` command is used to assign classification to each object. The grayscaling allows for the object to be turned into a black and white image with shades of gray, this makes it simple for the detection of objects and backgrounds in a given image set. Once that is done the `cv2.threshold()` command will create an image from the given data, in the case with this code it was done both regularly and inverted to provide accuracy in the final cropped image. After this is done, `cv2.findContours()` is used find edges in the object image and trace accordingly. Afterwards, the `np.zeros_like()` is used to cut the outer edges to mask the image. The two thresholds are then added together by layering on top of one another using the `cv2.bitwise_and()` command. The images are then output on each step as shown below.

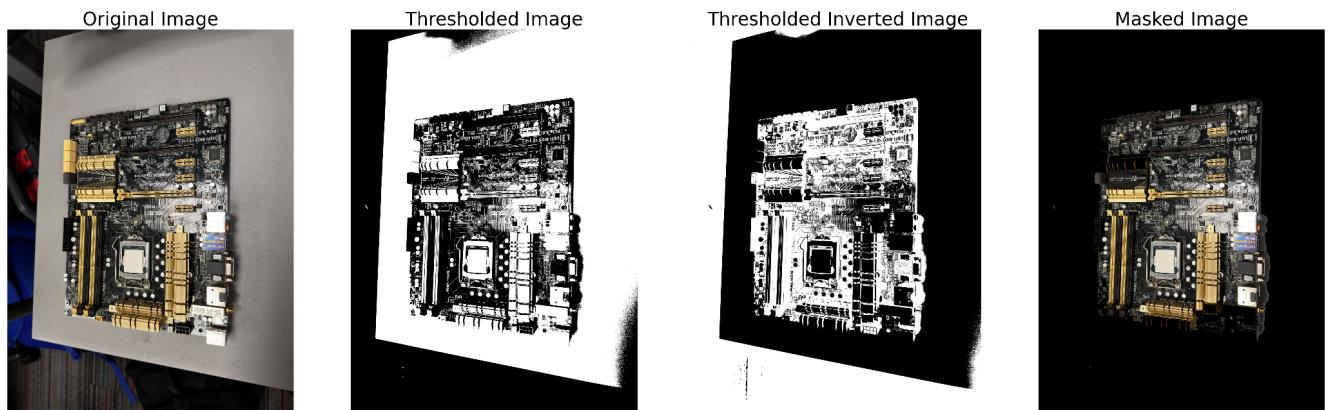


Figure 3: Motherboard Image Masking

The results show that the masking worked utilizing the inverted and regular method, with the exception of the parts at the bottom of the motherboard being darkened.

2.2 - YOLOv8 Training and Evaluation

YOLOv8 was used as the base model throughout this part of the code, with the addition of training to be done on the model. The *data.yaml* file was used as the basis where each part of the components are to be taken from. The *yolov8n.pt* file held all the model data that was trained.

2.2.1 Training

Training the model utilized the folders within the data file, using the *.train()* command. Running the program through 1 epoch for a low epoch output then 100 epochs for a high epoch output. The results are shown below.

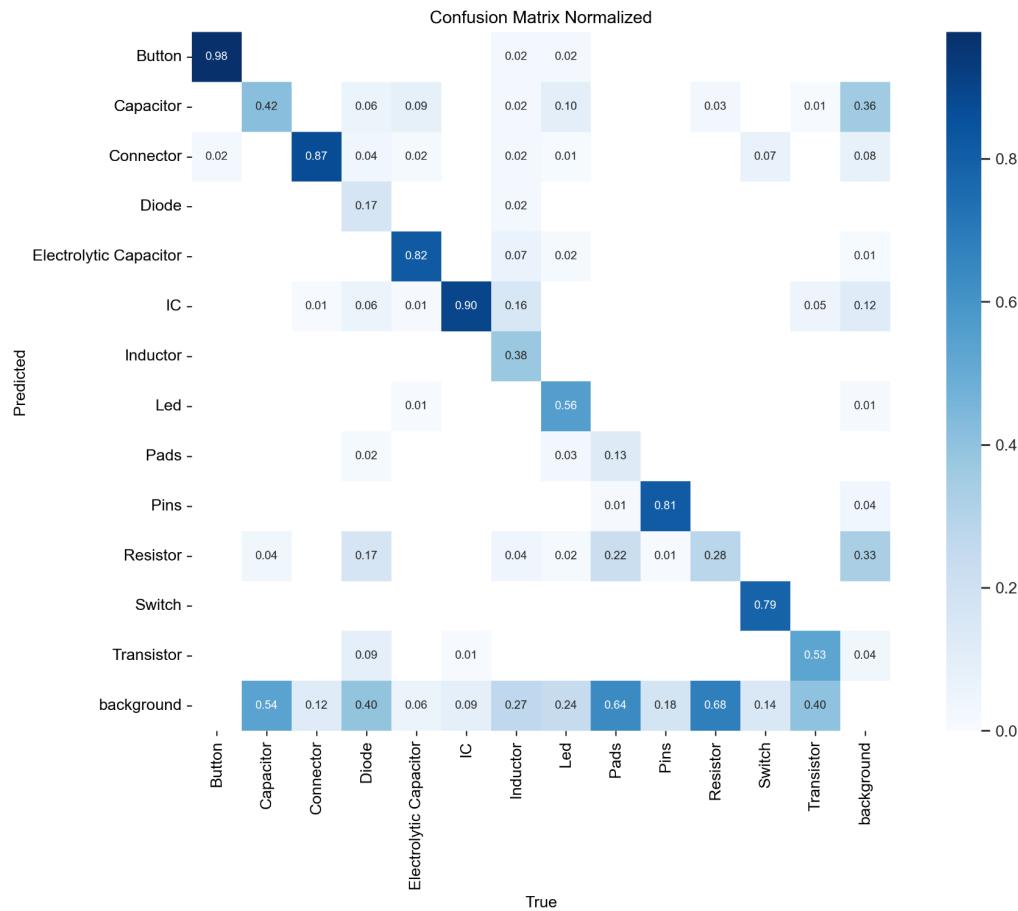


Figure 4: Confusion Matrix for YOLOv8 Trained Model

The confusion matrix showed somewhat accurate results as per standards. The places it had the least confidence were the pads and diodes.

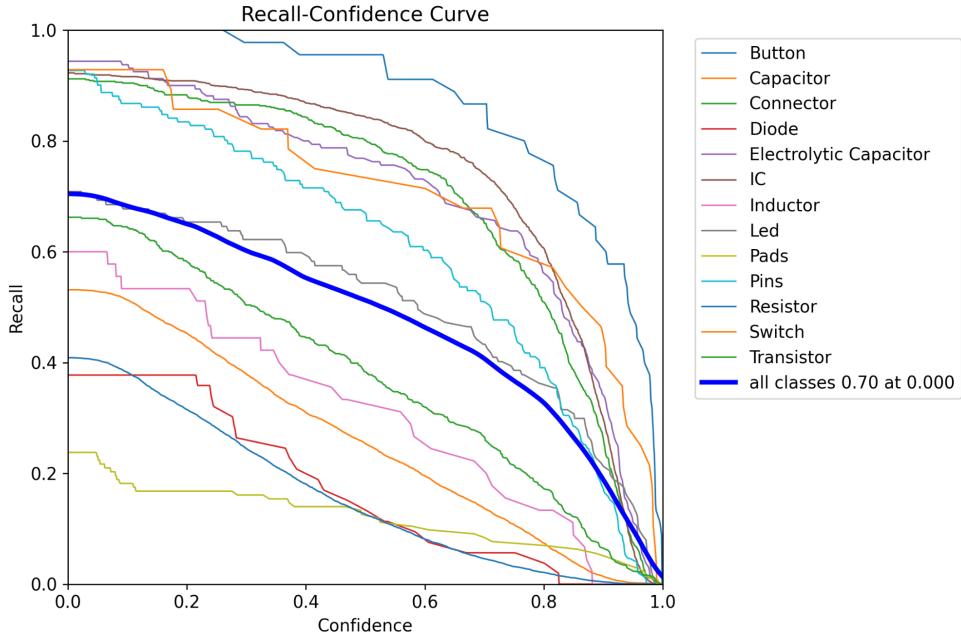


Figure 5: Recall-Confidence Curve for YOLOv8 Trained Model

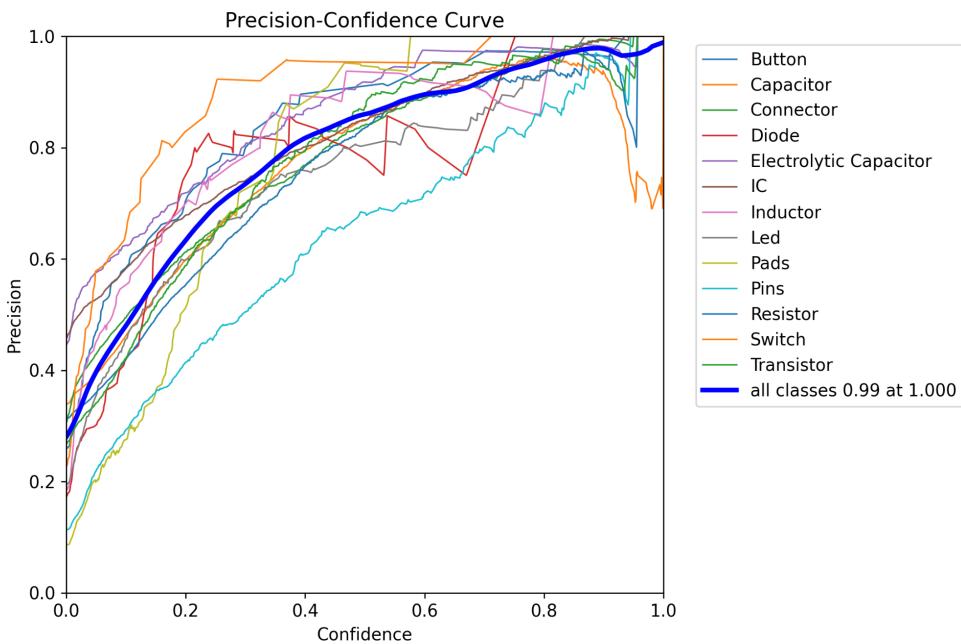


Figure 6: Precision-Confidence Curve for YOLOv8 Trained Model

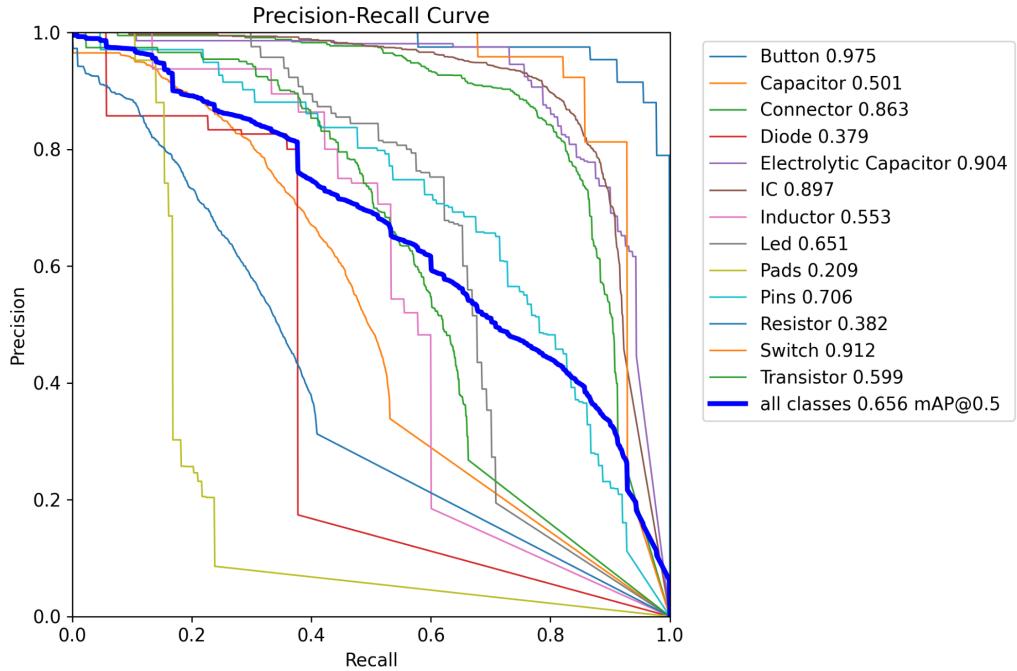


Figure 7: Precision-Recall Curve for YOLOv8 Trained Model

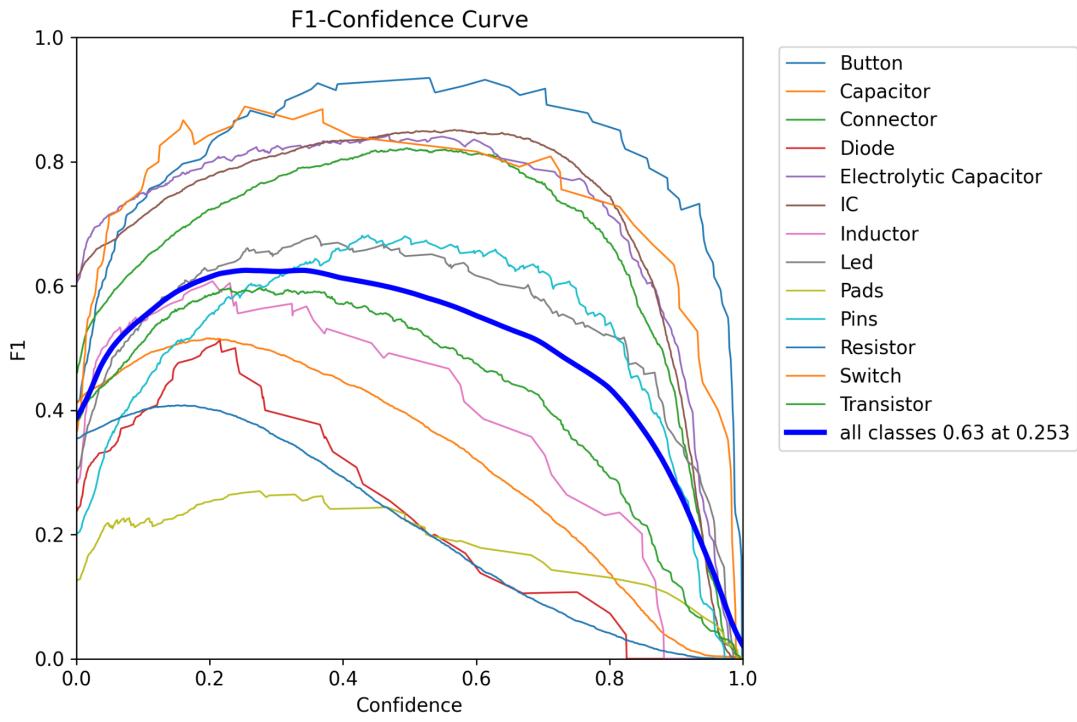


Figure 8: F1-Confidence Curve for YOLOv8 Trained Model

Each of the confidence and precision curves showed that button was the least confident and the capacitor was the most in detection. This indicates that there will be a correlation when seeing the final labeled output images. The following below shows the final results of the trained model.

Class	Images	Instances	Box(P)	R	mAP50	mAP50-95:	18/18 [00:21<00:00, 1.18s/it]
all	105	19108	0.736	0.6	0.656	0.457	
Button	105	45	0.803	0.978	0.975	0.763	
Capacitor	105	7251	0.702	0.377	0.501	0.25	
Connector	105	659	0.702	0.865	0.863	0.646	
Diode	105	53	0.821	0.26	0.379	0.264	
Electrolytic	105	160	0.808	0.842	0.904	0.604	
Capacitor	105	1322	0.743	0.893	0.897	0.653	
IC	105	45	0.786	0.444	0.553	0.452	
Inductor	105	127	0.687	0.622	0.651	0.426	
Led	105	143	0.727	0.161	0.209	0.143	
Pads	105	151	0.506	0.781	0.706	0.473	
Pins	105	8600	0.665	0.243	0.382	0.183	
Resistor	105	28	0.921	0.833	0.912	0.766	
Switch	105	524	0.702	0.504	0.599	0.316	
Transistor	105						

Speed: 3.5ms preprocess, 100.8ms inference, 0.0ms loss, 54.2ms postprocess per image
Results saved to runs\detect\AER850_Project3_Trained_Model16

Figure 9: Model Results for YOLOv8 Trained Model

2.2.2 Evaluation

The following below are the results for each of the evaluation images in figure 2.

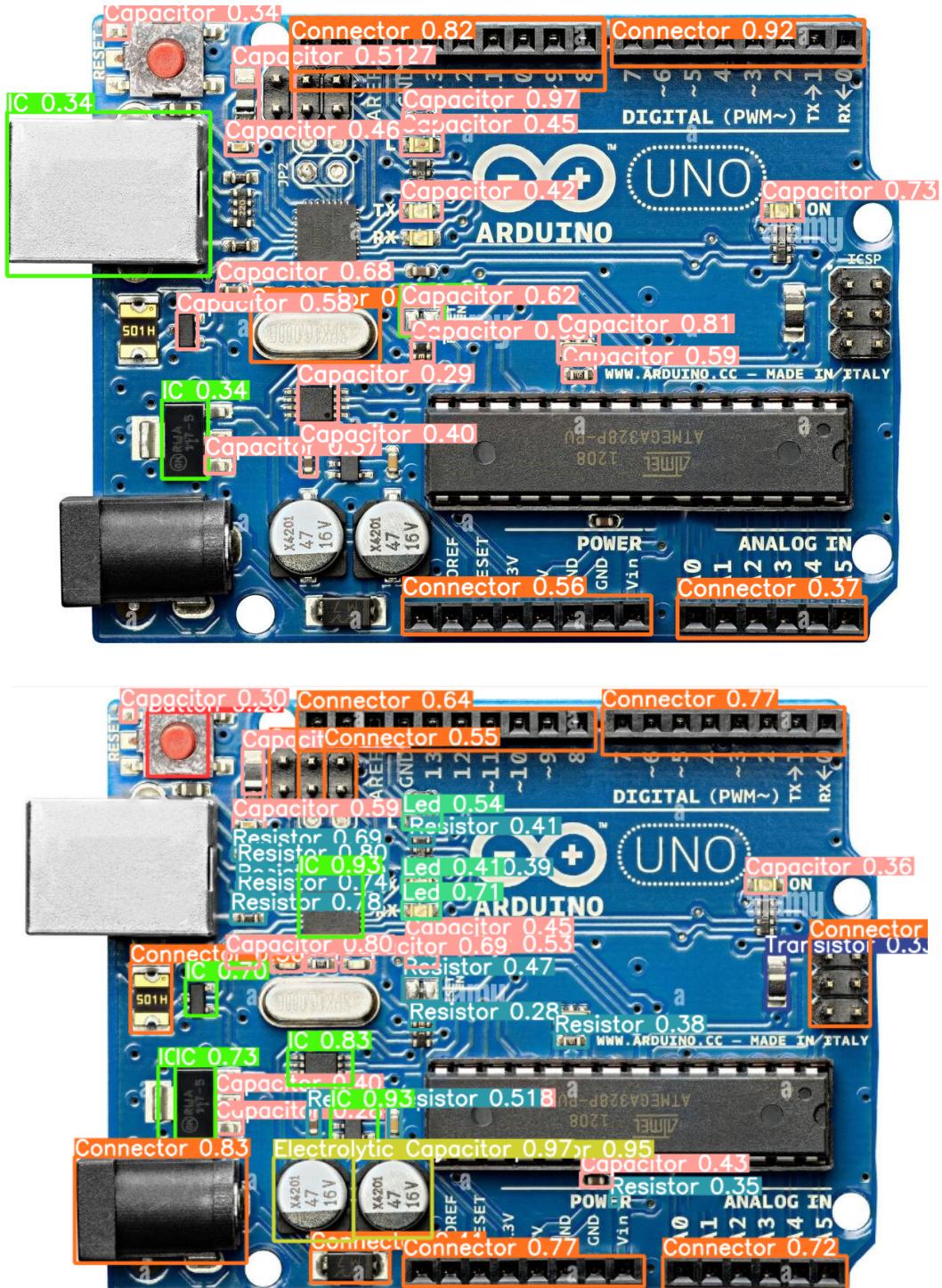


Figure 10: Low Epoch (Top) and High Epoch (Bottom) YOLOv8 Trained Evaluations for Arduino UNO Board

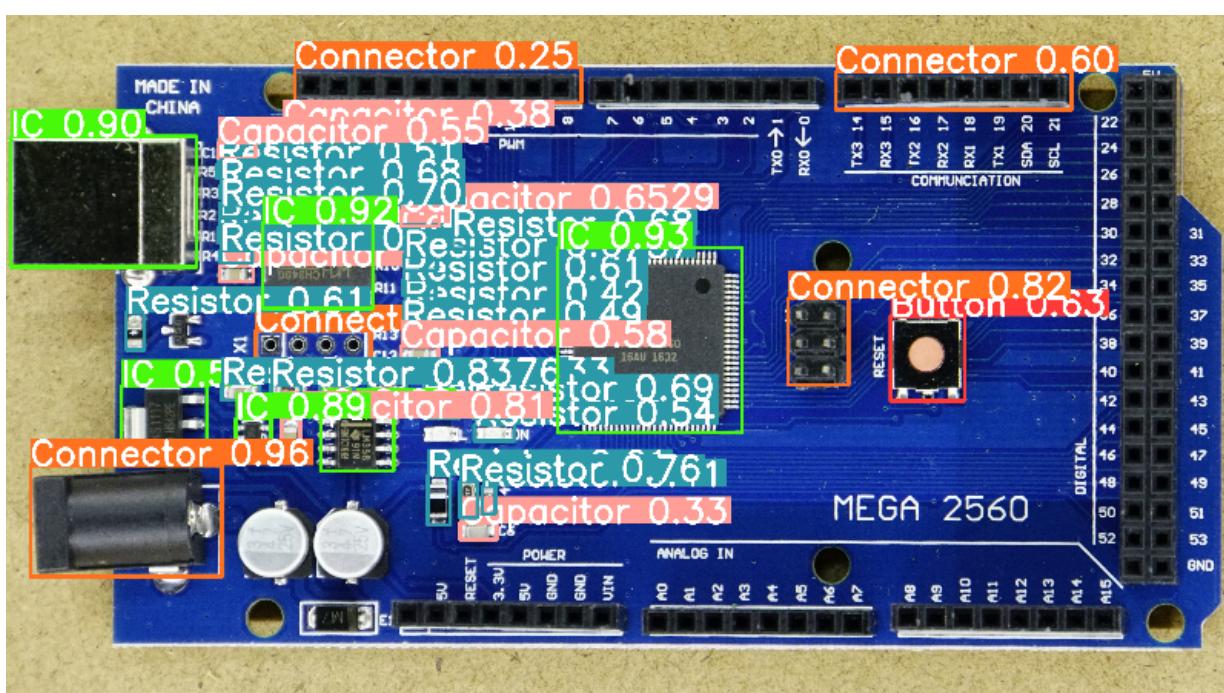
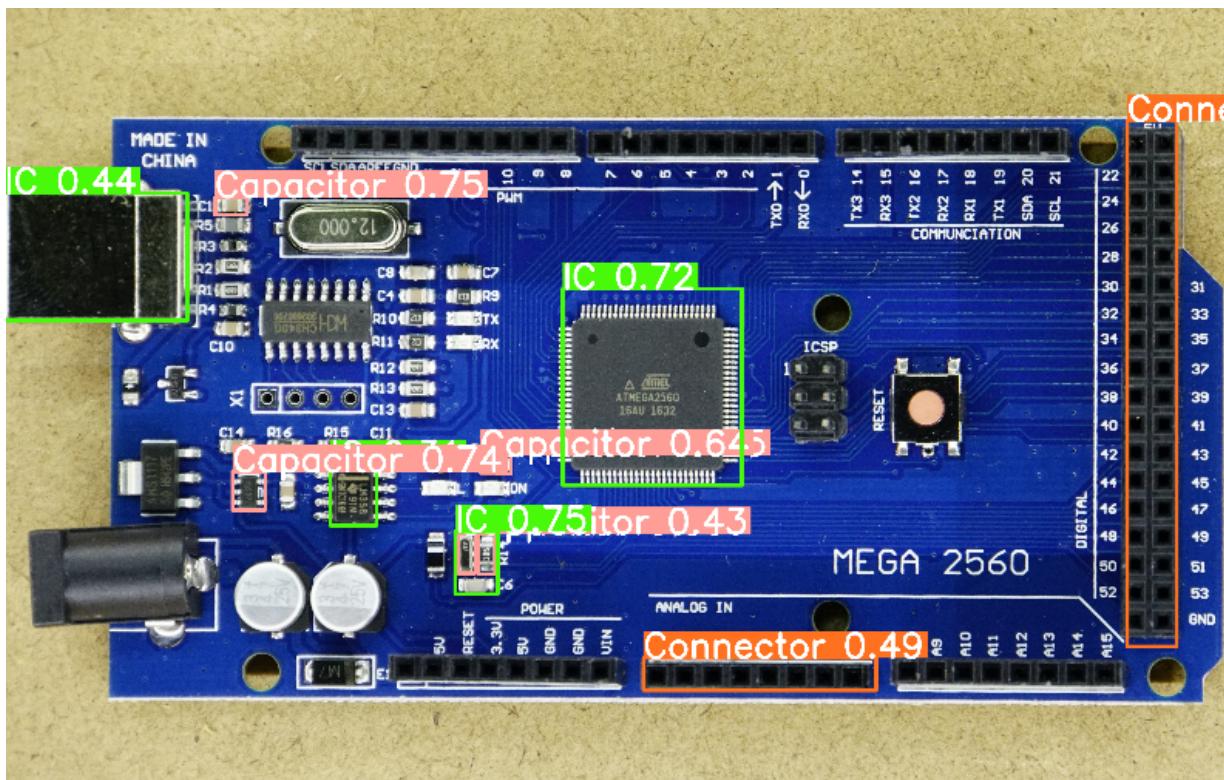


Figure 11: Low Epoch (Top) and High Epoch (Bottom) YOLOv8 Trained Evaluations for Arduino MEGA 2560

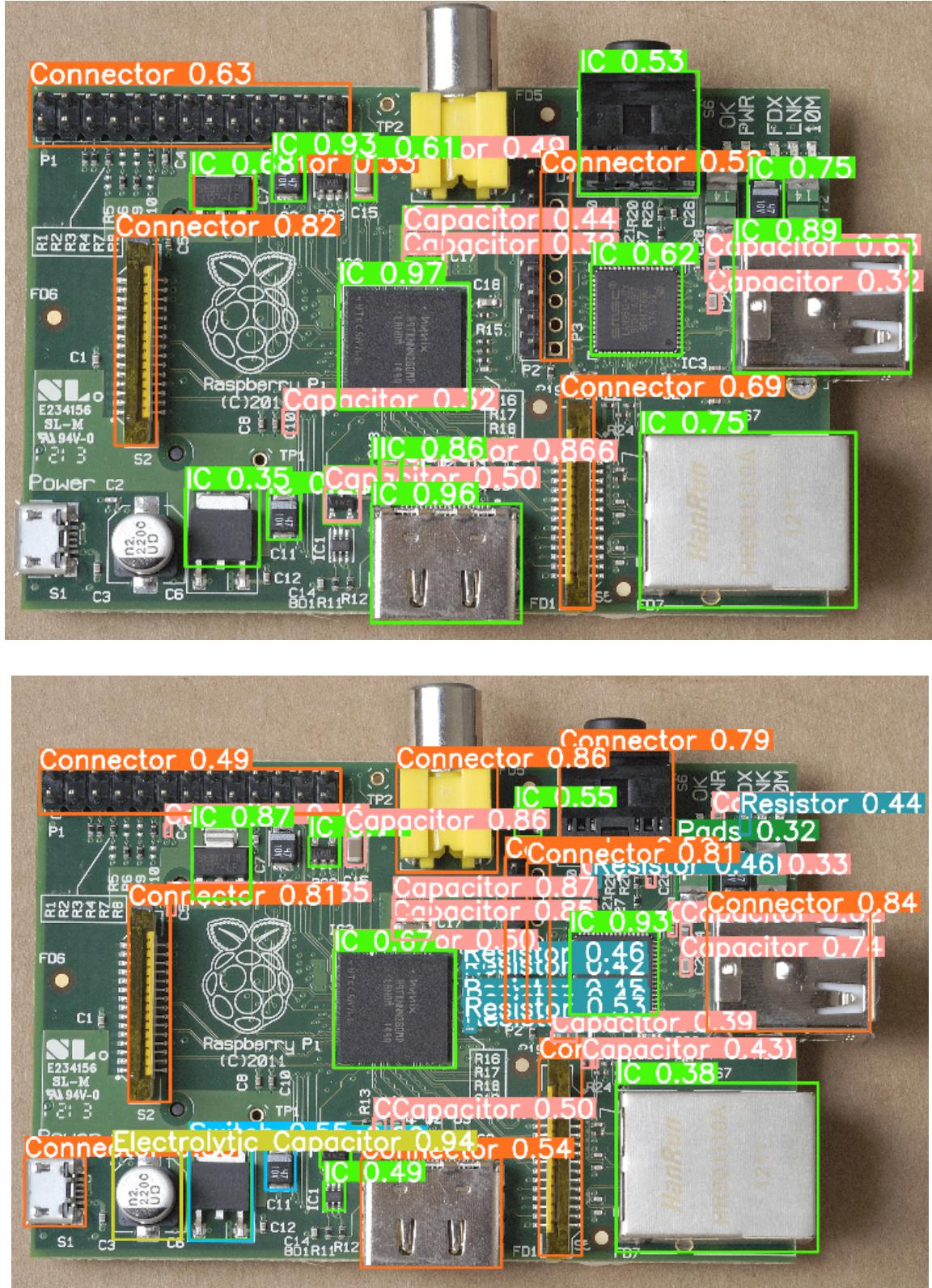


Figure 12: Low Epoch (Top) and High Epoch (Bottom) YOLOv8 Trained Evaluations for Raspberry PI C

In terms of the comparison between low and high epochs, the high epochs allows for more detection of components. The only output image that suffered a lot of detection loss was the arduino mega circuit, the connectors and capacitors were not fully detected. The reason for this is because more fine tuning is required to allow for more detection in the output. The *batch* size was 3 which could be increased to 5, while the *imgsz* size was put to the minimum 900 which could be increased to 1200. Computer requirements also lead to longer run times, as such lower parameters were used as the output.

3. Conclusion

This project helped in object masking and utilizing formed models to be trained. The process that goes into image masking allows for the analysis of circuit component detection. Utilizing this allows for the automation of circuit detection in factory work.

References

- [1] Dr. Reza Faieghi “AER850 Project #3”
<https://courses.torontomu.ca/d2l/le/content/804341/viewContent/5432841/View> [Accessed 12/9/2023]

Appendix

The following link is for the GitHub repository, all the code and folder designations are found in the zip file linked alongside the submission of this report:

https://github.com/Mehtab0Singh/AER850_Project_3_MehtabSingh